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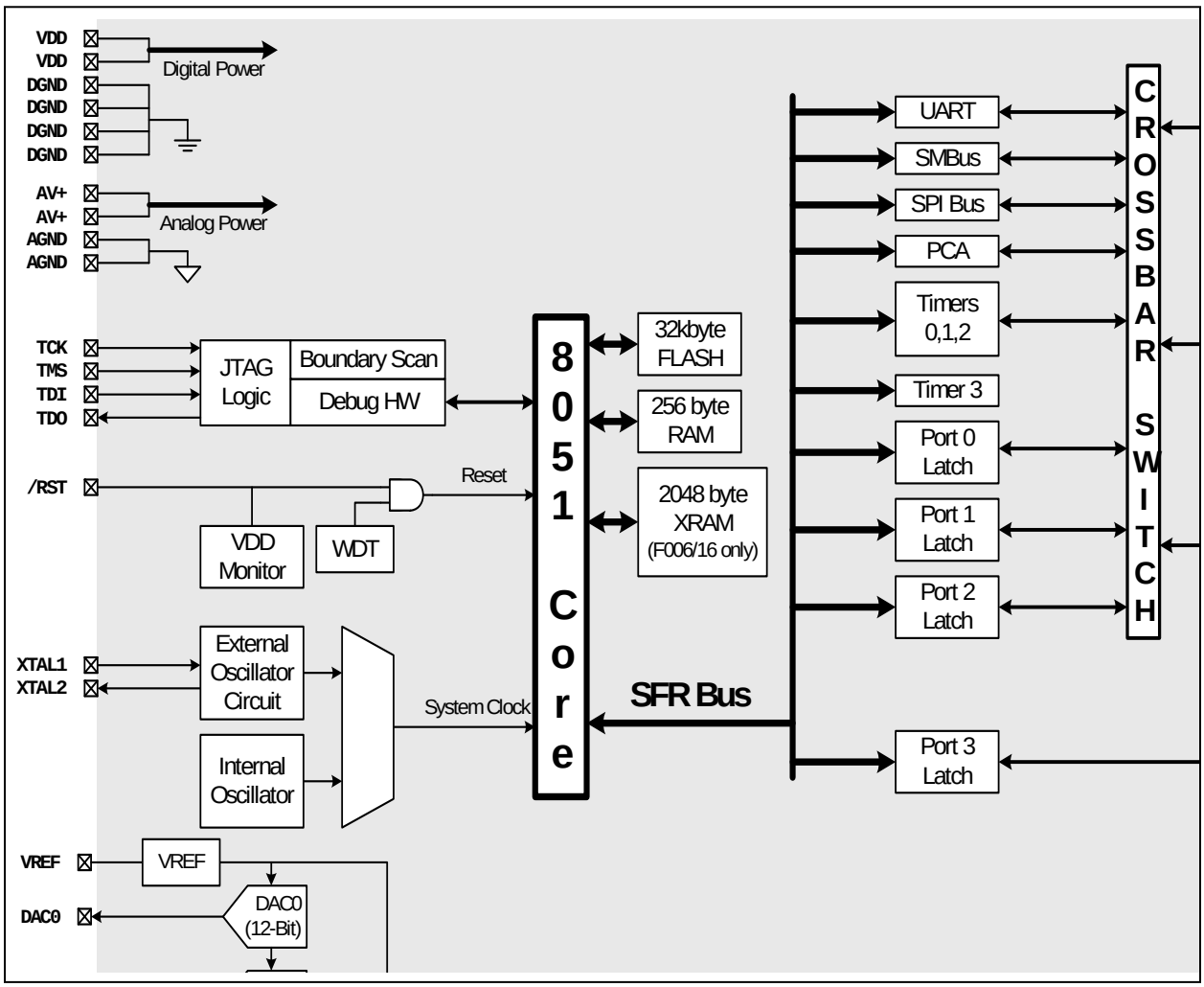
What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	SMBus (2-Wire/I²C), SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	16
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-TQFP
Supplier Device Package	48-TQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f016r

Figure 1.2. C8051F001/06/11/16 Block Diagram



1.2. On-Board Memory

The CIP-51 has a standard 8051 program and data address configuration. It includes 256 bytes of data RAM, with the upper 128 bytes dual-mapped. Indirect addressing accesses the upper 128 bytes of general purpose RAM, and direct addressing accesses the 128 byte SFR address space. The lower 128 bytes of RAM are accessible via direct and indirect addressing. The first 32 bytes are addressable as four banks of general-purpose registers, and the next 16 bytes can be byte addressable or bit addressable.

The CIP-51 in the C8051F005/06/07/15/16/17 MCUs additionally has a 2048 byte RAM block in the external data memory address space. This 2048 byte block can be addressed over the entire 64k external data memory address range (see Figure 1.6).

The MCU's program memory consists of 32k + 128 bytes of FLASH. This memory may be reprogrammed in-system in 512 byte sectors, and requires no special off-chip programming voltage. The 512 bytes from addresses 0x7E00 to 0x7FFF are reserved for factory use. There is also a single 128-byte sector at address 0x8000 to 0x807F, which may be useful as a small table for software constants or as additional program space. See Figure 1.6 for the MCU system memory map.

Figure 1.6. On-Board Memory Map

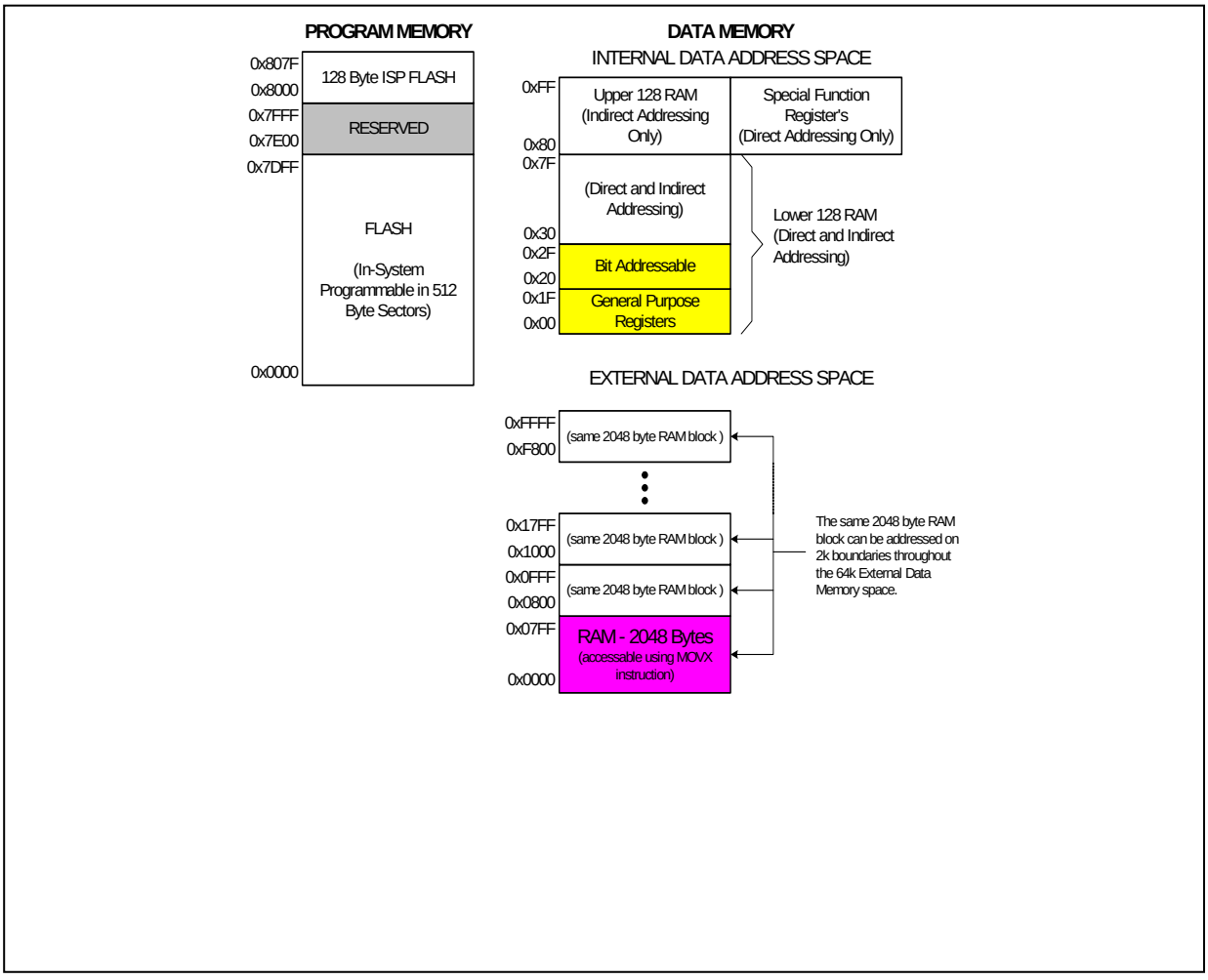


Figure 5.3. Temperature Sensor Transfer Function

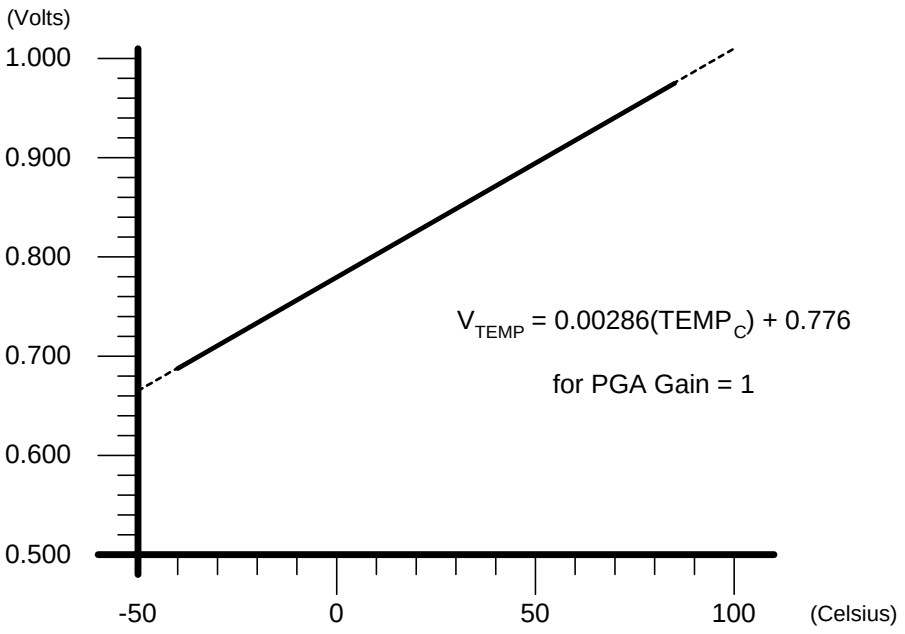


Figure 5.4. AMX0CF: AMUX Configuration Register (C8051F00x)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	-	-	AIN67IC	AIN45IC	AIN23IC	AIN01IC	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xBA

Bits7-4: UNUSED. Read = 0000b; Write = don't care
Bit3: AIN67IC: AIN6, AIN7 Input Pair Configuration Bit
0: AIN6 and AIN7 are independent singled-ended inputs
1: AIN6, AIN7 are (respectively) +, - differential input pair
Bit2: AIN45IC: AIN4, AIN5 Input Pair Configuration Bit
0: AIN4 and AIN5 are independent singled-ended inputs
1: AIN4, AIN5 are (respectively) +, - differential input pair
Bit1: AIN23IC: AIN2, AIN3 Input Pair Configuration Bit
0: AIN2 and AIN3 are independent singled-ended inputs
1: AIN2, AIN3 are (respectively) +, - differential input pair
Bit0: AIN01IC: AIN0, AIN1 Input Pair Configuration Bit
0: AIN0 and AIN1 are independent singled-ended inputs
1: AIN0, AIN1 are (respectively) +, - differential input pair

NOTE: The ADC Data Word is in 2's complement format for channels configured as differential.

Figure 5.6. ADC0CF: ADC Configuration Register (C8051F00x)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
ADCSC2	ADCSC1	ADCSC0	-	-	AMPGN2	AMPGN1	AMPGN0	01100000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xBC

Bits7-5: ADCSC2-0: ADC SAR Conversion Clock Period Bits
000: SAR Conversion Clock = 1 System Clock
001: SAR Conversion Clock = 2 System Clocks
010: SAR Conversion Clock = 4 System Clocks
011: SAR Conversion Clock = 8 System Clocks
1xx: SAR Conversion Clock = 16 Systems Clocks
(Note: the SAR Conversion Clock should be ≤ 2MHz)
Bits4-3: UNUSED. Read = 00b; Write = don't care
Bits2-0: AMPGN2-0: ADC Internal Amplifier Gain
000: Gain = 1
001: Gain = 2
010: Gain = 4
011: Gain = 8
10x: Gain = 16
11x: Gain = 0.5

Figure 6.7. ADC0CN: ADC Control Register (C8051F01x)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
ADCEN	ADCTM	ADCINT	ADBUSY	ADSTM1	ADSTM0	ADWINT	ADLJST	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xE8

Bit7: ADCEN: ADC Enable Bit
0: ADC Disabled. ADC is in low power shutdown.
1: ADC Enabled. ADC is active and ready for data conversions.

Bit6: ADCTM: ADC Track Mode Bit
0: When the ADC is enabled, tracking is always done unless a conversion is in process
1: Tracking Defined by ADSTM1-0 bits
ADSTM1-0:
00: Tracking starts with the write of 1 to ADBUSY and lasts for 3 SAR clocks
01: Tracking started by the overflow of Timer 3 and last for 3 SAR clocks
10: ADC tracks only when CNVSTR input is logic low
11: Tracking started by the overflow of Timer 2 and last for 3 SAR clocks

Bit5: ADCINT: ADC Conversion Complete Interrupt Flag
(Must be cleared by software)
0: ADC has not completed a data conversion since the last time this flag was cleared
1: ADC has completed a data conversion

Bit4: ADBUSY: ADC Busy Bit
Read
0: ADC Conversion complete or no valid data has been converted since a reset. The falling edge of ADBUSY generates an interrupt when enabled.
1: ADC Busy converting data
Write
0: No effect
1: Starts ADC Conversion if ADSTM1-0 = 00b

Bits3-2: ADSTM1-0: ADC Start of Conversion Mode Bits
00: ADC conversion started upon every write of 1 to ADBUSY
01: ADC conversions taken on every overflow of Timer 3
10: ADC conversion started upon every rising edge of CNVSTR
11: ADC conversions taken on every overflow of Timer 2

Bit1: ADWINT: ADC Window Compare Interrupt Flag
(Must be cleared by software)
0: ADC Window Comparison Data match has not occurred
1: ADC Window Comparison Data match occurred

Bit0: ADLJST: ADC Left Justify Data Bit
0: Data in ADC0H:ADC0L Registers is right justified
1: Data in ADC0H:ADC0L Registers is left justified

6.3. ADC Programmable Window Detector

The ADC programmable window detector is very useful in many applications. It continuously compares the ADC output to user-programmed limits and notifies the system when an out-of-band condition is detected. This is especially effective in an interrupt-driven system, saving code space and CPU bandwidth while delivering faster system response times. The window detector interrupt flag (ADWINT in ADC0CN) can also be used in polled mode. The high and low bytes of the reference words are loaded into the ADC Greater-Than and ADC Less-Than registers (ADC0GTH, ADC0GTL, ADC0LTH, and ADC0LTL). Figure 6.14 and Figure 6.15 show example comparisons for reference. Notice that the window detector flag can be asserted when the measured data is inside or outside the user-programmed limits, depending on the programming of the ADC0GTx and ADC0LTx registers.

Figure 6.10. ADC0GTH: ADC Greater-Than Data High Byte Register (C8051F01x)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xC5

Bits7-0:
The high byte of the ADC Greater-Than Data Word.

Figure 6.11. ADC0GTL: ADC Greater-Than Data Low Byte Register (C8051F01x)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xC4

Bits7-0:
The low byte of the ADC Greater-Than Data Word.
Definition:
ADC Greater-Than Data Word = ADC0GTH:ADC0GTL

Figure 6.12. ADC0LTH: ADC Less-Than Data High Byte Register (C8051F01x)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xC7

Bits7-0:
The high byte of the ADC Less-Than Data Word.

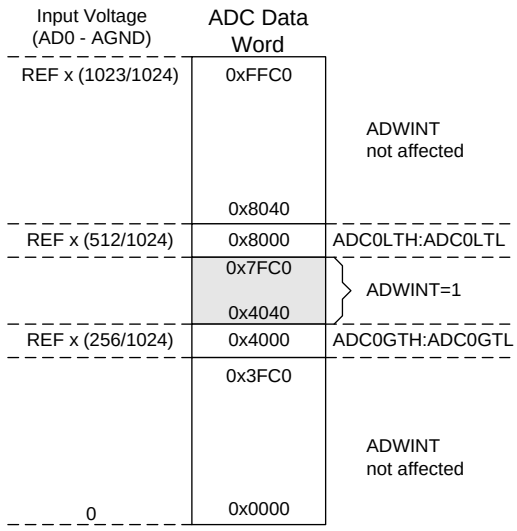
Figure 6.13. ADC0LTL: ADC Less-Than Data Low Byte Register (C8051F01x)

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xC6

Bits7-0:
These bits are the low byte of the ADC Less-Than Data Word.

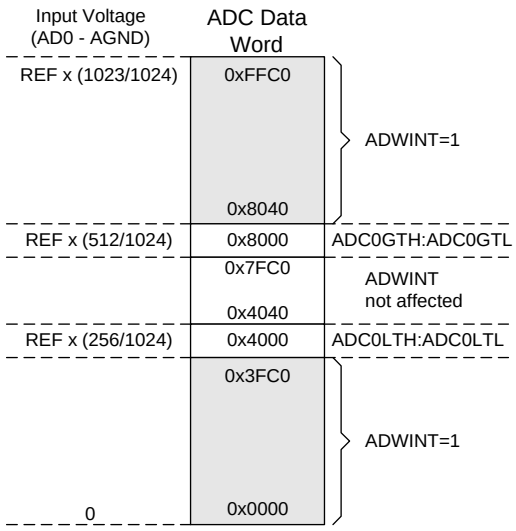
Definition:
ADC Less-Than Data Word = ADC0LTH:ADC0LTL

Figure 6.15. 10-Bit ADC Window Interrupt Examples, Left Justified Data



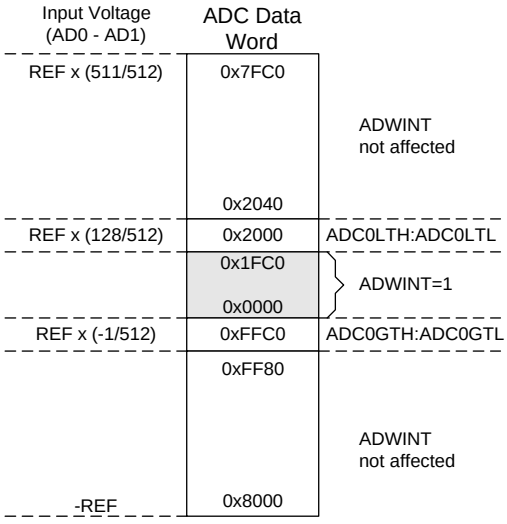
Given:
AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 1,
ADC0LTH:ADC0LTL = 0x8000,
ADC0GTH:ADC0GTL = 0x4000.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x8000 and > 0x4000.



Given:
AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 1,
ADC0LTH:ADC0LTL = 0x4000,
ADC0GTH:ADC0GTL = 0x8000.

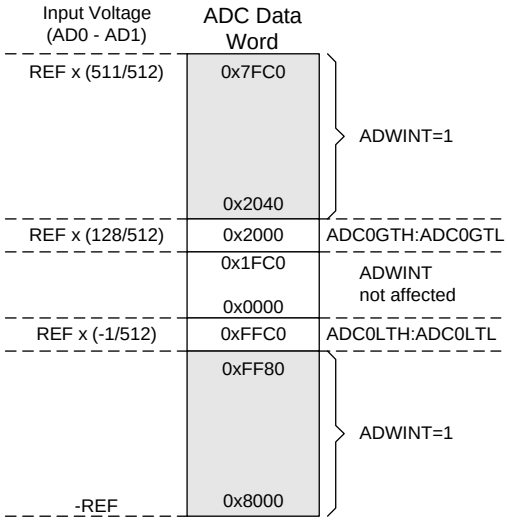
An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x4000 or > 0x8000.



Given:

AMX0SL = 0x00, AMX0CF = 0x01, ADLJST = 1,
ADC0LTH:ADC0LTL = 0x2000,
ADC0GTH:ADC0GTL = 0xFFC0.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0x2000 and > 0xFFC0. (Two's Complement math.)



Given:

AMX0SL = 0x00, AMX0CF = 0x01, ADLJST = 1,
ADC0LTH:ADC0LTH = 0xFFC0,
ADC0GTH:ADC0GTL = 0x2000.

An ADC End of Conversion will cause an ADC Window Compare Interrupt (ADWINT=1) if the resulting ADC Data Word is < 0xFFC0 or > 0x2000. (Two's Complement math.)

Table 7.1. DAC Electrical Characteristics

VDD = 3.0V, AV+ = 3.0V, REF = 2.40V (REFBE=0), No Output Load unless otherwise specified.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
STATIC PERFORMANCE					
Resolution			12		bits
Integral Nonlinearity	For Data Word Range 0x014 to 0xFEB		±2		LSB
Differential Nonlinearity	Guaranteed Monotonic (codes 0x014 to 0xFEB)			±1	LSB
Output Noise	No Output Filter 100kHz Output Filter 10kHz Output Filter		250 128 41		µVrms
Offset Error	Data Word = 0x014		±3	±30	mV
Offset Tempco			6		ppm/°C
Full-Scale Error			±20	±60	mV
Full-Scale Error Tempco			10		ppm/°C
VDD Power-Supply Rejection Ratio			-60		dB
Output Impedance in Shutdown Mode	DACnEN=0		100		kΩ
Output Current			±300		µA
Output Short Circuit Current	Data Word = 0xFFF		15		mA
DYNAMIC PERFORMANCE					
Voltage Output Slew Rate	Load = 40pF		0.44		V/µs
Output Settling Time To ½ LSB	Load = 40pF, Output swing from code 0xFFF to 0x014		10		µs
Output Voltage Swing		0		REF-1LSB	V
Startup Time	DAC Enable asserted		10		µs
ANALOG OUTPUTS					
Load Regulation	I_L = 0.01mA to 0.3mA at code 0xFFF		60		ppm
CURRENT CONSUMPTION (each DAC)					
Power Supply Current (AV+ supplied to DAC)	Data Word = 0x7FF		110	400	µA

Table 8.1. Comparator Electrical Characteristics

VDD = 3.0V, AV+ = 3.0V, -40°C to +85°C unless otherwise specified.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Response Time1	(CP+) – (CP-) = 100mV (Note 1)		4		µs
Response Time2	(CP+) – (CP-) = 10mV (Note 1)		12		µs
Common Mode Rejection Ratio			1.5	4	mV/V
Positive Hysteresis1	CPnHYP1-0 = 00		0	1	mV
Positive Hysteresis2	CPnHYP1-0 = 01	2	4.5	7	mV
Positive Hysteresis3	CPnHYP1-0 = 10	4	9	13	mV
Positive Hysteresis4	CPnHYP1-0 = 11	10	17	25	mV
Negative Hysteresis1	CPnHYN1-0 = 00		0	1	mV
Negative Hysteresis2	CPnHYN1-0 = 01	2	4.5	7	mV
Negative Hysteresis3	CPnHYN1-0 = 10	4	9	13	mV
Negative Hysteresis4	CPnHYN1-0 = 11	10	17	25	mV
Inverting or Non-inverting Input Voltage Range		-0.25		(AV+) + 0.25	V
Input Capacitance			7		pF
Input Bias Current		-5	0.001	+5	nA
Input Offset Voltage		-10		+10	mV
POWER SUPPLY					
Power-up Time	CPnEN from 0 to 1		20		µs
Power Supply Rejection			0.1	1	mV/V
Supply Current	Operating Mode (each comparator) at DC		1.5	10	µA

Note 1: CPnHYP1-0 = CPnHYN1-0 = 00.

Figure 9.2. REF0CN: Reference Control Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	-	-	-	TEMPE	BIASE	REFBE	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xD1

Bits7-3: UNUSED. Read = 00000b; Write = don't care
Bit2: TEMPE: Temperature Sensor Enable Bit
0: Internal Temperature Sensor Off.
1: Internal Temperature Sensor On.
Bit1: BIASE: Bias Enable Bit for ADC and DAC's
0: Internal Bias Off.
1: Internal Bias On (required for use of ADC or DAC's).
Bit0: REFBE: Internal Voltage Reference Buffer Enable Bit
0: Internal Reference Buffer Off. System reference can be driven from external source on VREF pin.
1: Internal Reference Buffer On. System reference provided by internal voltage reference.

Table 9.1. Reference Electrical Characteristics

VDD = 3.0V, AV+ = 3.0V, -40°C to +85°C unless otherwise specified.

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
INTERNAL REFERENCE (REFBE = 1)					
Output Voltage	25°C ambient	2.34	2.43	2.50	V
VREF Short Circuit Current				30	mA
VREF Power Supply Current (supplied by AV+)			50		µA
VREF Temperature Coefficient			15		ppm/°C
Load Regulation	Load = (0-to-200µA) to AGND (Note 1)		0.5		ppm/µA
VREF Turn-on Time1	4.7µF tantalum, 0.1µF ceramic bypass		2		ms
VREF Turn-on Time2	0.1µF ceramic bypass		20		µs
VREF Turn-on Time3	no bypass cap		10		µs
EXTERNAL REFERENCE (REFBE = 0)					
Input Voltage Range		1.00		(AV+) – 0.3V	V
Input Current			0	1	µA

Note 1: The reference can only source current. When driving an external load, it is recommended to add a load resistor to AGND.

Figure 10.10. IP: Interrupt Priority

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
-	-	PT2	PS	PT1	PX1	PT0	PX0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xB8

Bits7-6: UNUSED. Read = 11b, Write = don't care.

Bit5: PT2 Timer 2 Interrupt Priority Control.
This bit sets the priority of the Timer 2 interrupts.
0: Timer 2 interrupts set to low priority level.
1: Timer 2 interrupts set to high priority level.

Bit4: PS: Serial Port (UART) Interrupt Priority Control.
This bit sets the priority of the Serial Port (UART) interrupts.
0: UART interrupts set to low priority level.
1: UART interrupts set to high priority level.

Bit3: PT1: Timer 1 Interrupt Priority Control.
This bit sets the priority of the Timer 1 interrupts.
0: Timer 1 interrupts set to low priority level.
1: Timer 1 interrupts set to high priority level.

Bit2: PX1: External Interrupt 1 Priority Control.
This bit sets the priority of the External Interrupt 1 interrupts.
0: External Interrupt 1 set to low priority level.
1: External Interrupt 1 set to high priority level.

Bit1: PT0: Timer 0 Interrupt Priority Control.
This bit sets the priority of the Timer 0 interrupts.
0: Timer 0 interrupt set to low priority level.
1: Timer 0 interrupt set to high priority level.

Bit0: PX0: External Interrupt 0 Priority Control.
This bit sets the priority of the External Interrupt 0 interrupts.
0: External Interrupt 0 set to low priority level.
1: External Interrupt 0 set to high priority level.

Figure 10.14. EIP2: Extended Interrupt Priority 2

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PXVLD	-	PX7	PX6	PX5	PX4	PADC0	PT3	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xF7

Bit7: PXVLD: External Clock Source Valid (XTLVLD) Interrupt Priority Control.
This bit sets the priority of the XTLVLD interrupt.
0: XTLVLD interrupt set to low priority level.
1: XTLVLD interrupt set to high priority level.

Bit6: Reserved: Must write 0. Reads 0.

Bit5: PX7: External Interrupt 7 Priority Control.
This bit sets the priority of the External Interrupt 7.
0: External Interrupt 7 set to low priority level.
1: External Interrupt 7 set to high priority level.

Bit4: PX6: External Interrupt 6 Priority Control.
This bit sets the priority of the External Interrupt 6.
0: External Interrupt 6 set to low priority level.
1: External Interrupt 6 set to high priority level.

Bit3: PX5: External Interrupt 5 Priority Control.
This bit sets the priority of the External Interrupt 5.
0: External Interrupt 5 set to low priority level.
1: External Interrupt 5 set to high priority level.

Bit2: PX4: External Interrupt 4 Priority Control.
This bit sets the priority of the External Interrupt 4.
0: External Interrupt 4 set to low priority level.
1: External Interrupt 4 set to high priority level.

Bit1: PADC0: ADC End of Conversion Interrupt Priority Control.
This bit sets the priority of the ADC0 End of Conversion Interrupt.
0: ADC0 End of Conversion interrupt set to low priority level.
1: ADC0 End of Conversion interrupt set to high priority level.

Bit0: PT3: Timer 3 Interrupt Priority Control.
This bit sets the priority of the Timer 3 interrupts.
0: Timer 3 interrupt set to low priority level.
1: Timer 3 interrupt set to high priority level.

Figure 13.4. RSTSRC: Reset Source Register

R	R/W	R/W	R/W	R	R	R/W	R	Reset Value
JTAGRST	CNVRSEF	C0RSEF	SWRSEF	WDTRSF	MCDRSF	PORSF	PINRSF	xxxxxxxx
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xEF

(Note: Do not use read-modify-write operations on this register.)

Bit7: JTAGRST. JTAG Reset Flag.
0: JTAG is not currently in reset state.
1: JTAG is in reset state.

Bit6: CNVRSEF: Convert Start Reset Source Enable and Flag
Write
0: CNVSTR is not a reset source
1: CNVSTR is a reset source (active low)
Read
0: Source of prior reset was not from CNVSTR
1: Source of prior reset was from CNVSTR

Bit5: C0RSEF: Comparator 0 Reset Enable and Flag
Write
0: Comparator 0 is not a reset source
1: Comparator 0 is a reset source (active low)
Read
Note: The value read from C0RSEF is not defined if Comparator 0 has not been enabled as a reset source.
0: Source of prior reset was not from Comparator 0
1: Source of prior reset was from Comparator 0

Bit4: SWRSF: Software Reset Force and Flag
Write
0: No Effect
1: Forces an internal reset. /RST pin is not effected.
Read
0: Prior reset source was not from write to the SWRSF bit.
1: Prior reset source was from write to the SWRSF bit.

Bit3: WDTRSF: Watchdog Timer Reset Flag
0: Source of prior reset was not from WDT timeout.
1: Source of prior reset was from WDT timeout.

Bit2: MCDRSF: Missing Clock Detector Flag
0: Source of prior reset was not from Missing Clock Detector timeout.
1: Source of prior reset was from Missing Clock Detector timeout.

Bit1: PORSF: Power-On Reset Force and Flag
Write
0: No effect
1: Forces a Power-On Reset. /RST is driven low.
Read
0: Source of prior reset was not from POR.
1: Source of prior reset was from POR.

Bit0: PINRSF: HW Pin Reset Flag
0: Source of prior reset was not from /RST pin.
1: Source of prior reset was from /RST pin.

15.3. General Purpose Port I/O

Each MCU has four byte-wide, bi-directional parallel ports that can be used general purpose I/O. Each port is accessed through a corresponding special function register (SFR) that is both byte addressable and bit addressable. When writing to a port, the value written to the SFR is latched to maintain the output data value at each pin. When reading, the logic levels of the port's input pins are returned regardless of the XBRn settings (i.e. even when the pin is assigned to another signal by the Crossbar, the Port Register can always still read its corresponding Port I/O pin). The exception to this is the execution of the *read-modify-write* instructions. The *read-modify-write* instructions when operating on a port SFR are the following: ANL, ORL, XRL, JBC, CPL, INC, DEC, DJNZ and MOV, CLR or SET, when the destination is an individual bit in a port SFR. For these instructions, the value of the port register (not the pin) is read, modified, and written back to the SFR.

15.4. Configuring Ports Which are not Pinned Out

P2 and P3 are not pinned out on the F001/06/11/16. P1, P2, and P3 are not pinned out on the F002/07/12/17. These port registers (and corresponding interrupts, where applicable) are still available for software use in these reduced pin count MCUs. Whether used or not in software, it is recommended not to let these port drivers go to high impedance state. This is prevented after reset by having the weak pull-ups enabled as described in the XBR2 register. It is recommended that each output driver for ports not pinned out should be configured as push-pull using the corresponding PRTnCF register. This will inhibit a high impedance state even if the weak pull-up is disabled.

Figure 15.6. P0: Port0 Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
P0.7	P0.6	P0.5	P0.4	P0.3	P0.2	P0.1	P0.0	11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0x80

Bits7-0: P0.[7:0]
(Write – Output appears on I/O pins per XBR0, XBR1, and XBR2 Registers)
0: Logic Low Output.
1: Logic High Output (high-impedance if corresponding PRT0CF.n bit = 0)
(Read – Regardless of XBR0, XBR1, and XBR2 Register settings).
0: P0.n pin is logic low.
1: P0.n pin is logic high.

Figure 15.7. PRT0CF: Port0 Configuration Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xA4

Bits7-0: PRT0CF.[7:0]: Output Configuration Bits for P0.7-P0.0 (respectively)
0: Corresponding P0.n Output mode is Open-Drain.
1: Corresponding P0.n Output mode is Push-Pull.

(Note: When SDA, SCL, and RX appear on any of the P0 I/O, each are open-drain regardless of the value of PRT0CF).

Figure 15.11. P2: Port2 Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
P2.7	P2.6	P2.5	P2.4	P2.3	P2.2	P2.1	P2.0	11111111
Bit7	Bit6	Bit	Bit4	Bit3	Bit2	Bit1	Bit0 (bit addressable)	SFR Address: 0xA0

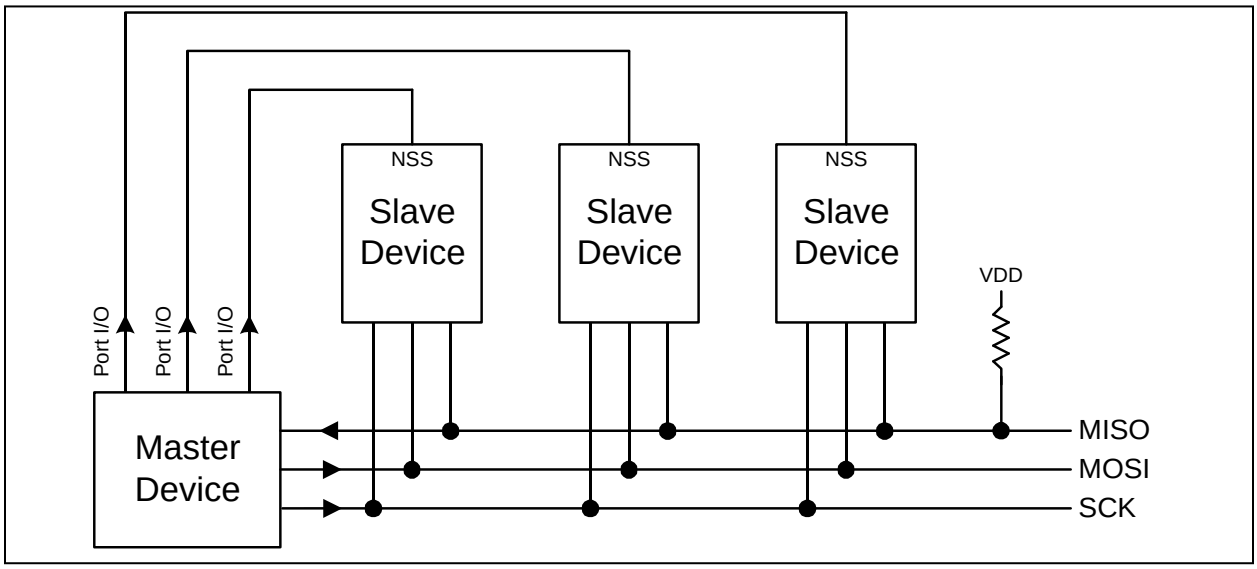
Bits7-0: P2.[7:0]
(Write – Output appears on I/O pins per XBR0, XBR1, and XBR2 registers)
0: Logic Low Output.
1: Logic High Output (high-impedance if corresponding PRT2CF.n bit = 0)
(Read – Regardless of XBR0, XBR1, and XBR2 Register settings).
0: P2.n is logic low.
1: P2.n is logic high.

Figure 15.12. PRT2CF: Port2 Configuration Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xA6

Bits7-0: PRT2CF.[7:0]: Output Configuration Bits for P2.7-P2.0 (respectively)
0: Corresponding P2.n Output mode is Open-Drain.
1: Corresponding P2.n Output mode is Push-Pull.

Figure 17.2. Typical SPI Interconnection



17.1. Signal Descriptions

The four signals used by the SPI (MOSI, MISO, SCK, NSS) are described below.

17.1.1. Master Out, Slave In

The master-out, slave-in (MOSI) signal is an output from a master device and an input to slave devices. It is used to serially transfer data from the master to the slave. Data is transferred most-significant bit first.

17.1.2. Master In, Slave Out

The master-in, slave-out (MISO) signal is an output from a slave device and an input to the master device. It is used to serially transfer data from the slave to the master. Data is transferred most-significant bit first. A SPI slave places the MISO pin in a high-impedance state when the slave is not selected.

17.1.3. Serial Clock

The serial clock (SCK) signal is an output from the master device and an input to slave devices. It is used to synchronize the transfer of data between the master and slave on the MOSI and MISO lines.

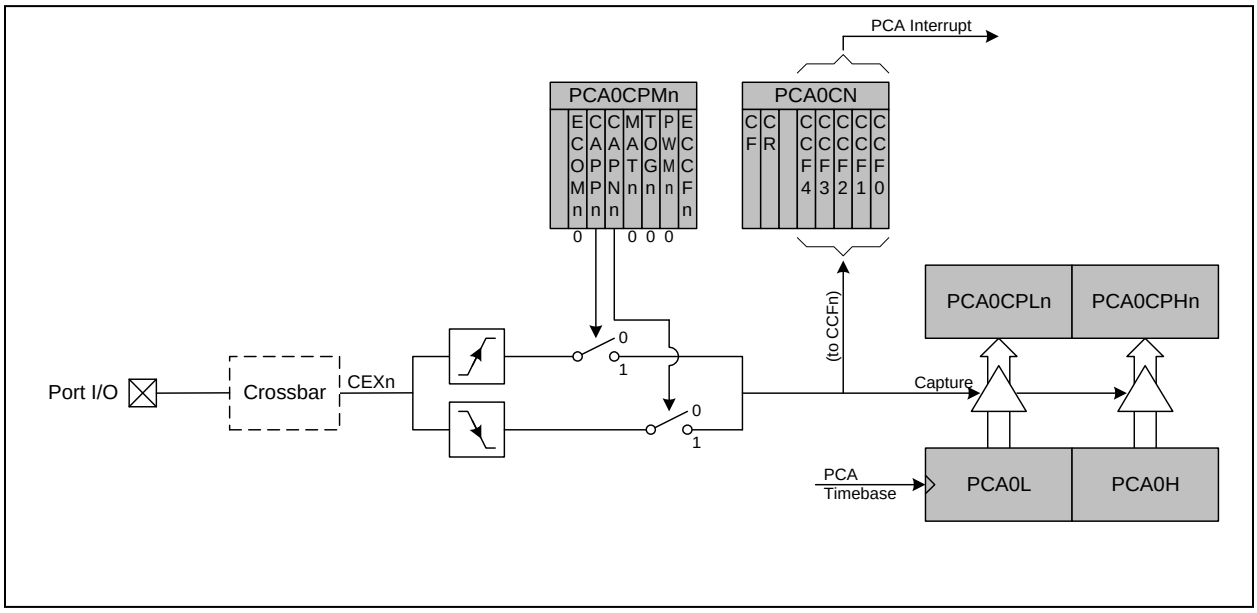
17.1.4. Slave Select

The slave select (NSS) signal is an input used to select the SPI module when in slave mode by a master, or to disable the SPI module when in master mode. When in slave mode, it is pulled low to initiate a data transfer and remains low for the duration of the transfer.

20.1.1. Edge-triggered Capture Mode

In this mode, a valid transition on the CEXn pin causes the PCA to capture the value of the PCA counter/timer and load it into the corresponding module's 16-bit capture/compare register (PCA0CPLn and PCA0CPHn). The CAPPn and CAPNn bits in the PCA0CPMn register are used to select the type of transition that triggers the capture: low-to-high transition (positive edge), high-to-low transition (negative edge), or either transition (positive or negative edge). When a capture occurs, the Capture/Compare Flag (CCFn) in PCA0CN is set to logic 1 and an interrupt request is generated if CCF interrupts are enabled. The CCFn bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software.

Figure 20.3. PCA Capture Mode Diagram



20.2. PCA Counter/Timer

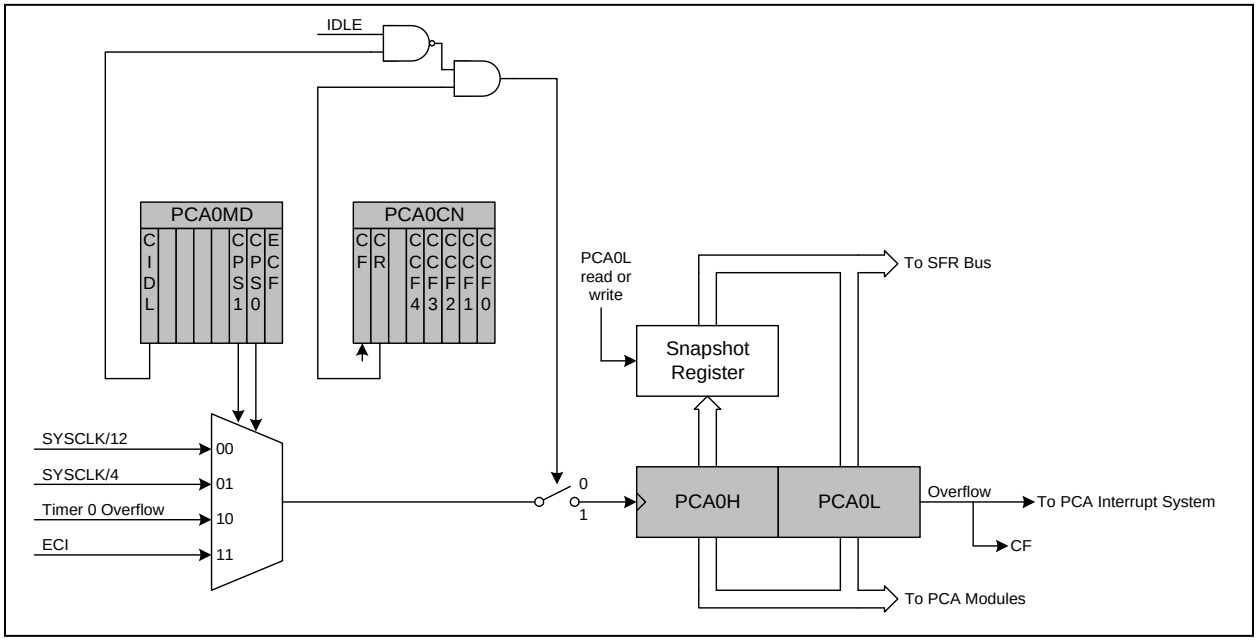
The 16-bit PCA counter/timer consists of two 8-bit SFRs: PCA0L and PCA0H. PCA0H is the high byte (MSB) of the 16-bit counter/timer and PCA0L is the low byte (LSB). Reading PCA0L automatically latches the value of PCA0H at the same time. By reading the PCA0L Register first, this allows the PCA0H value to be held (at the time PCA0L was read) until the user reads the PCA0H Register. Reading PCA0H or PCA0L does not disturb the counter operation. The CPS1 and CPS0 bits in the PCA0MD register select the timebase for the counter/timer as shown in Table 20.2.

When the counter/timer overflows from 0xFFFF to 0x0000, the Counter Overflow Flag (CF) in PCA0MD is set to logic 1 and an interrupt request is generated if CF interrupts are enabled. Setting the ECF bit in PCA0MD to logic 1 enables the CF flag to generate an interrupt request. The CF bit is not automatically cleared by hardware when the CPU vectors to the interrupt service routine, and must be cleared by software. (Note: PCA0 interrupts must be globally enabled before CF interrupts are recognized. PCA0 interrupts are globally enabled by setting the EA bit (IE.7) and the EPCA0 bit in EIE1 to logic 1.) Clearing the CIDL bit in the PCA0MD register allows the PCA to continue normal operation while the microcontroller core is in Idle mode.

Table 20.2. PCA Timebase Input Options

CPS1	CPS0	Timebase
0	0	System clock divided by 12
0	1	System clock divided by 4
1	0	Timer 0 overflow
1	1	High-to-low transitions on ECI (max rate = system clock divided by 4)

Figure 20.7. PCA Counter/Timer Block Diagram



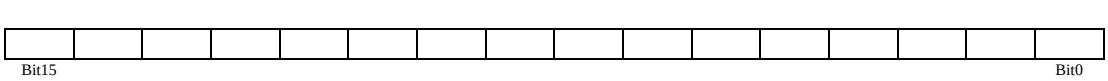
21. JTAG (IEEE 1149.1)

Each MCU has an on-chip JTAG interface and logic to support boundary scan for production and in-system testing, Flash read and write operations, and non-intrusive in-circuit debug. The JTAG interface is fully compliant with the IEEE 1149.1 specification. Refer to this specification for detailed descriptions of the Test Interface and Boundary-Scan Architecture. Access of the JTAG Instruction Register (IR) and Data Registers (DR) are as described in the Test Access Port and Operation of the IEEE 1149.1 specification.

The JTAG interface is via four dedicated pins on the MCU, which are TCK, TMS, TDI, and TDO. These pins are all 5V tolerant.

Through the 16-bit JTAG Instruction Register (IR), any of the eight instructions shown in Figure 21.1 can be commanded. There are three Data Registers (DR's) associated with JTAG Boundary-Scan, and four associated with Flash read/write operations on the MCU.

Figure 21.1. IR: JTAG Instruction Register



IR value	Instruction	Description
0x0000	EXTEST	Selects the Boundary Data Register for control and observability of all device pins
0x0002	SAMPLE/ PRELOAD	Selects the Boundary Data Register for observability and presetting the scan-path latches
0x0004	IDCODE	Selects device ID Register
0xFFFF	BYPASS	Selects Bypass Data Register
0x0082	Flash Control	Selects FLASHCON Register to control how the interface logic responds to reads and writes to the FLASHDAT Register
0x0083	Flash Data	Selects FLASHDAT Register for reads and writes to the Flash memory
0x0084	Flash Address	Selects FLASHADR Register which holds the address of all Flash read, write, and erase operations
0x0085	Flash Scale	Selects FLASHSCL Register which controls the prescaler used to generate timing signals for Flash operations